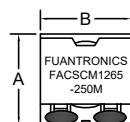


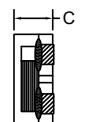
P/N: FACSCM1265-250M

RoHS

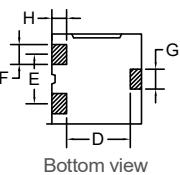
### Outline Dimensions(Unit:mm)



Top view



Side view

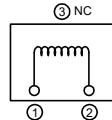


Bottom view

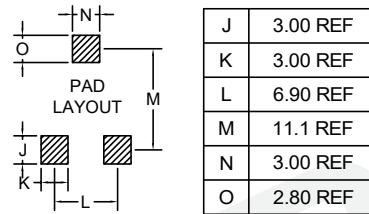


Marking

### Electronical Schematic



### Suggested Pad layout



\*\*\*Magnetic shielded structure: excellent resistance to electro magnetic interferenc(EMI).

\*\*\*Assemblage design, sturdy structure.

\*\*\*Small volume, high current, low magnetic loss, low ESR, small parasitic capacitance.

\*\*\*Temperature rise current and saturation current is less influenced by environment.

### Electrical Characteristics(@25°C)

Inductance 100KHz,0.1V	DC Resistor	Saturated current 3.8A	Temperature rise current 5.8A
25.0uH±20%	23.0mΩ Max	$L(3.8A)=80\% \cdot L_{0A} \text{ Typ}$	$T \leq 40^\circ\text{C} \text{ Typ}$

\*\*\*Saturation current: the actual value of DC current when the inductance decrease 20% of its initial value.

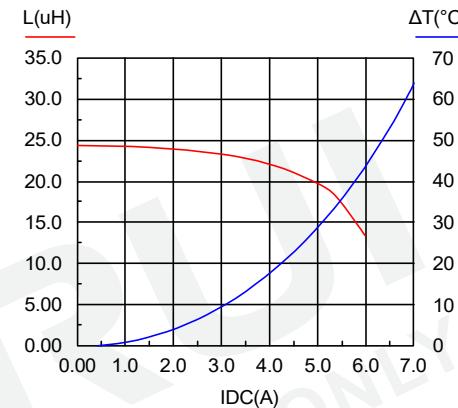
\*\*\*Temperature rise current: the actual value of DC current when the temperature rise is  $\Delta T=40^\circ\text{C}$ ( $T_a=25^\circ\text{C}$ ).

\*\*\*Operating Temperature:  $-40^\circ\text{C} \sim +125^\circ\text{C}$ .  
(Temperature rise included)

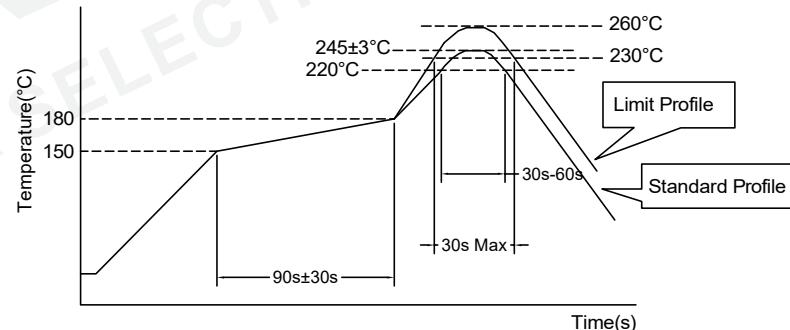
\*\*\*Storage Temperature:  $-40^\circ\text{C} \sim +125^\circ\text{C}$ .

\*\*\*Storage Humidity: RH10%~70%.

### Saturation current VS temperature rise current curve:



### Recommended Soldering Temperature Graph.



	Standard Profile	Standard Profile
Pre-heating	150~180°C, 90s±30s	
Heating	above 220°C, 30s-60s	above 240°C, 30s Max
Peak temperature	245°C±3°C	260°C, 10s
Cycle of reflow	2 times	2 times

				Tianchang Fuan Electronic Co Ltd www.fuantronics.net TEL: +86-550-7814888 FAX:+86-550-7831133	 Tolerances unless otherwise specified: (.X)±0.50    (.XX)±0.25 Unit of measurement: mm	Make: Qiumei.Liu  Checked: Beson.zhan  Approved: Anson.zhan	<b>DRAWING TITLE</b> HIGH CURRENT POWER INDUCTORS	Customer Name:
REV	DESCRIPTION	APPD	DATE					Document/Rev: 00
								Specification Sheet: 1 of 1
							Material Number: A341265XS280	Date of Recognition: Jan./02/2020